# 5-103168-2 ACTIVE

## AMPMODU | AMPMODU Headers

TE Internal #: 5-103168-2

PCB Mount Header, Vertical, Board-to-Board, 8 Position, 2.54 mm [.

1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

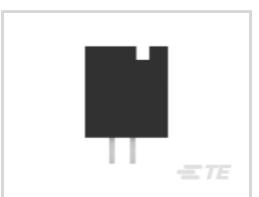
AMPMODU Headers

View on TE.com >



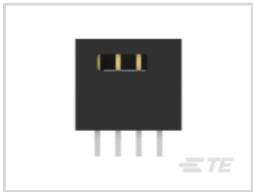
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 8
Number of Rows: 2

## **Features**

## **Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Footures	

#### Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	2
Board-to-Board Configuration	Parallel

## **Electrical Characteristics**

Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms

## **Body Features**



Connector Profile	Standard
Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Mating Retention Type	Detent Window
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	



Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	184
Packaging Type	Tray

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



## **Compatible Parts**



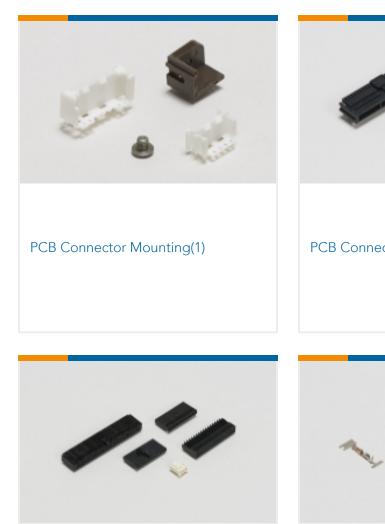








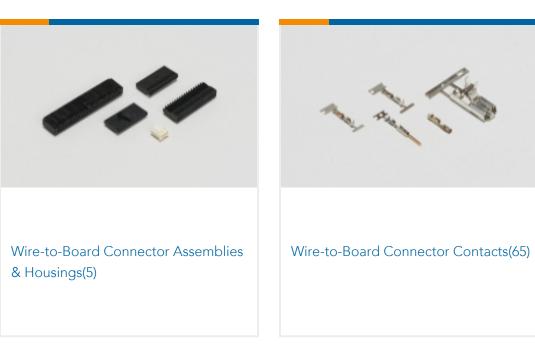
## Also in the Series | AMPMODU Headers







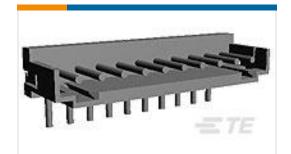




Customers Also Bought

PCB Mount Header, Vertical, Board-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers





TE Part #1-292253-1 CT CONN MT HDR ASSY H 11P NAT



TE Part #9-2176231-8
SMD Power Resistor: 3 Watt, 1% Tol



TE Part #1775443-2 EMIX CONN., 1.5MM PITCH, HDR, V /T, 2P



TE Part #5-103166-2 08 MODII HDR DRRA SHRD LF



TE Part #1393114-1 KUEP-3D15-24=KU-



TE Part #5-146278-2 02 MODII HDR SRST B/A .100CL



TE Part #32205074 GX518 1Pt100 W0.15 L5/D1.8mm



TE Part #5-103168-4
12 MODII HDR DRST SHRD .100CL



## **Documents**

## **Product Drawings**

08 MODII HDR DRST SHRD .100CL

English

## **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5-103168-2\_M.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5-103168-2\_M.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5-103168-2\_M.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the  $\pmb{\mathsf{Terms}}$  and  $\pmb{\mathsf{Conditions}}$  of use.

Datasheets & Catalog Pages

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## AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5

English

Product Environmental Compliance

MD\_5-103168-2\_01172018445\_dmtec

English

MD\_5-103168-2\_01172018445\_dmtec

English